

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	25	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	125	

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
FDS2672	FDS2672	13"	12mm	2500 units

FDS2672 N-Channel UltraFET Trench[®] MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	200			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		206		mV/°C
		V _{DS} = 160V, V _{GS} =0V			1	μA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 160V, V _{GS} =0V T _J = 55°C			10	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20V			±100	nA
On Chara	cteristics (Note 2)					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2	2.9	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		-11		mV/°C
		V _{GS} = 10V, I _D = 3.9A		59	70	
r _{DS(on)}	Drain to Source On Resistance	V _{GS} = 6V, I _D = 3.5A		63	80	mΩ
		V _{GS} = 10V, I _D = 3.9A, T _J = 125°C		124	148	1
9 _{FS}	Forward Transcondductance	V _{DS} = 10V,I _D = 3.9A		15		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			1905	2535	pF
C _{oss}	Output Capacitance	──V _{DS} = 100V, V _{GS} = 0V, f = 1MHz		100	135	pF
C _{rss}	Reverse Transfer Capacitance			30	45	pF
R _g	Gate Resistance	f = 1MHz		0.7		Ω
	g Characteristics					
t _{d(on)}	Turn-On Delay Time			22	35	ns
t _r	Rise Time			10	20	ns
t _{d(off)}	Turn-Off Delay Time			35	56	ns
t _f	Fall Time			10	20	ns
Q _{g(TOT)}	Total Gate Charge at 10V			33	46	nC
Q _{gs}	Gate to Source Gate Charge	V _{DD} =100V I _D = 3.9A		11		nC
Q _{gd}	Gate to Drain "Miller"Charge			7		nC
Drain-Sou	urce Diode Characteristics					
V _{SD}	Source to Drain Diode Voltage	V _{GS} = 0V, I _S = 3.9A		0.75	1.2	V
t _{rr}	Reverse Recovery Time	I _F = 3.9A, di/dt = 100A/μs		67	101	ns

Notes:
1: R_{0JA} is the sum of the junction-to-case and case-to- ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.

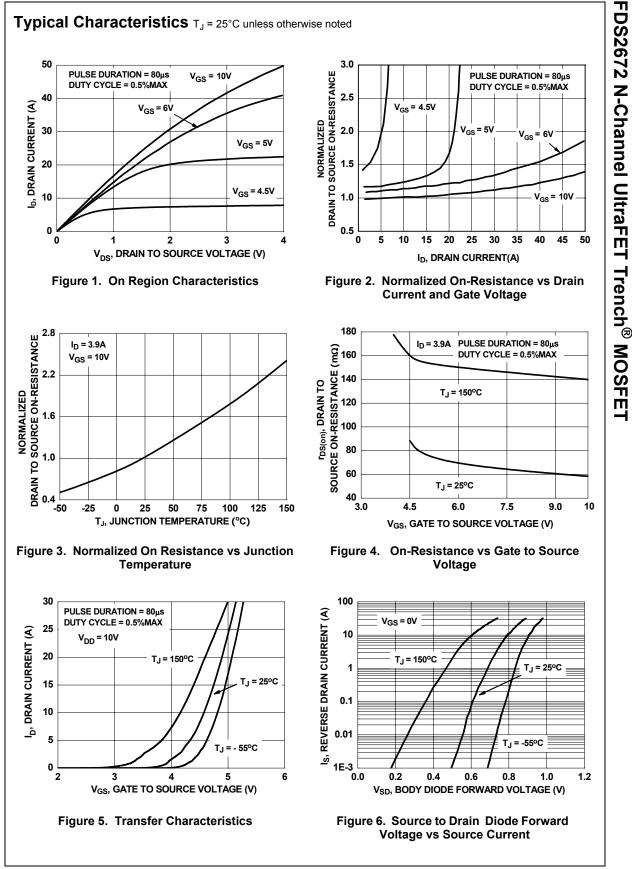




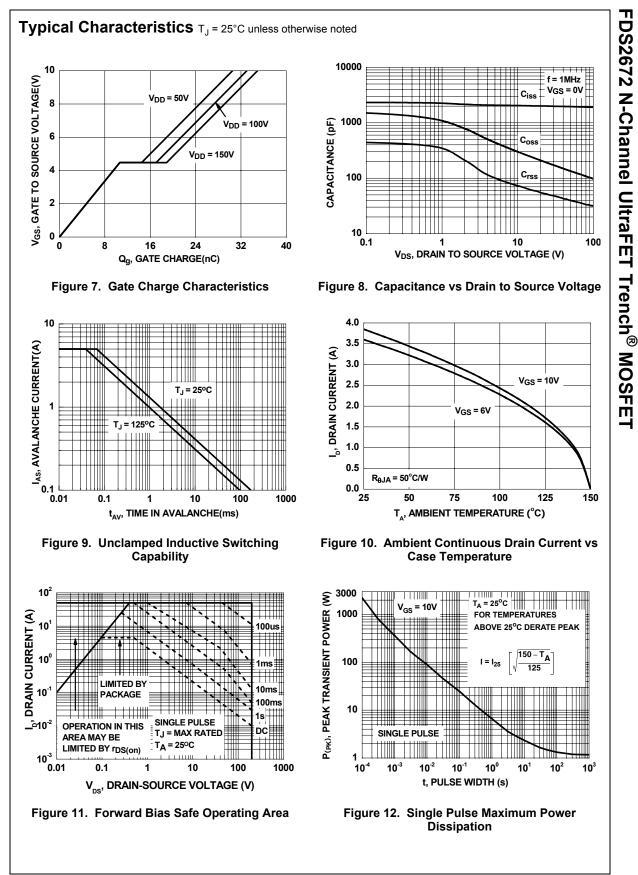


b) 125°C/W when mounted on a minimum pad .

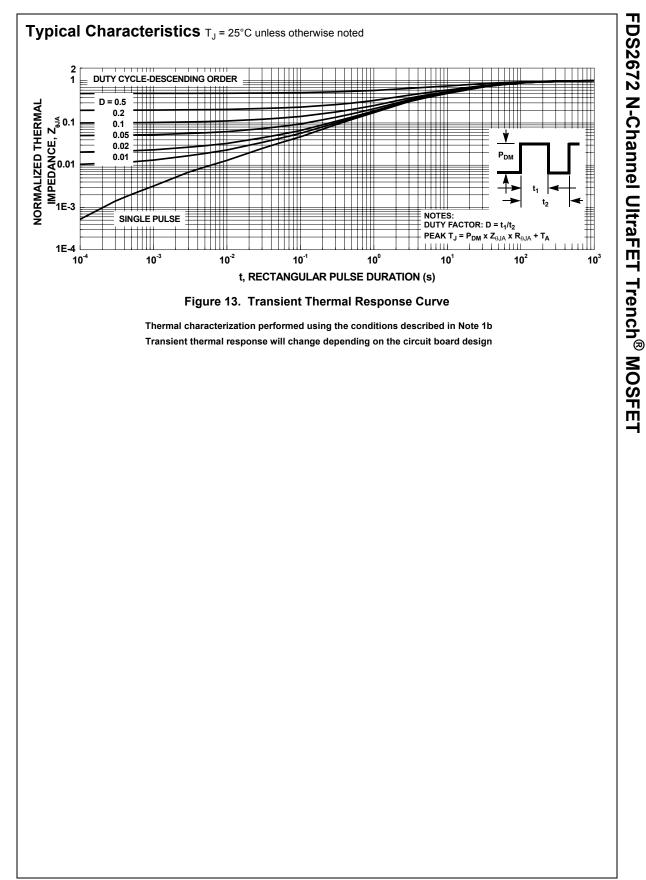
FDS2672 Rev. B



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